

IGBT Modules

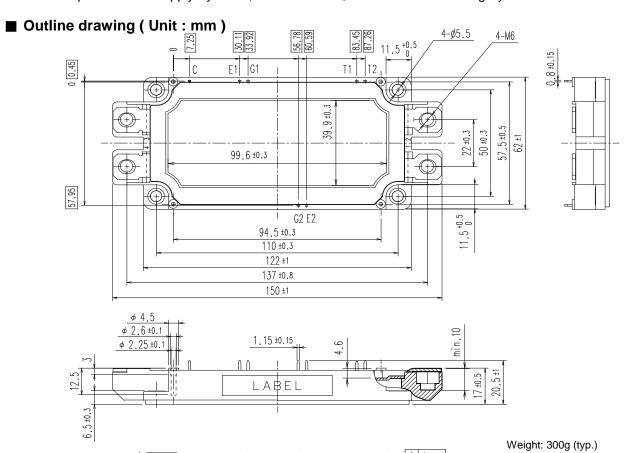
Power Module (V series) 1200V / 300A / 2-in-1 package

■ Features

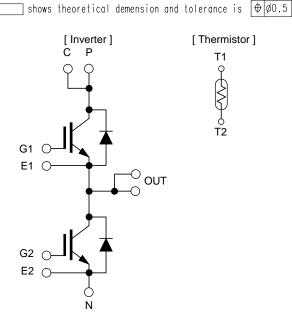
Low V_{CE(sat)} Low Inductance Module structure Solderless press-fit terminals

■ Applications

Inverter for Motor Drives, AC and DC Servo Drives
Uninterruptible Power Supply Systems, Wind Turbines, PV Power Conditioning Systems



■ Equivalent Circuit



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■ Absolute Maximum Ratings (at T_C= 25°C unless otherwise specified)

Items		Symbols	Conditions		Maximum Ratings	Units
Collector-Emitter voltage		V_{CES}			1200	V
Gate-Emitter voltage		V_{GES}			±20	V
Collector current		I _C	Continuous	$T_C=25^{\circ}C$ $T_C=100^{\circ}C$	450	
				T _C =100°C	300	
		I _C pulse	1ms		600	A
		-l _C			300	
		-I _C pulse	1ms		600	
Collector power dissipation		P _C	1 device		2000	W
Junction temperature		T _j			175	
Operating junction temperature		T _{jop}	T _{jop}		150	°C
(under switching conditions)						
Case temperature		T _c			125	
Storage temperature		T _{stg}			-40 ~ 125	
Isolation	between terminal and copper base (*1)	V	AC. 1min		2500	VAC
voltage	between thermistor and others (*2)	V_{iso}	AC: 1min.		2500	VAC
Screw	Mounting (*3)	-			3.5	N m
Torque	Terminals (*4)	-			4.5	

^(*1) All terminals should be connected together during the test.

(*3) Recommendable Value: 2.5-3.5 Nm (M5) (*4) Recommendable Value: 3.5-4.5 Nm (M6)

^(*2) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

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■ Electrical characteristics (at T_j= 25°C unless otherwise specified)

Items	Symbolo	Symbols Conditions		Ch	Units		
items	Symbols			min.	typ.	max.	Units
Zero gate voltage Collector current	I _{CES}	V _{GE} =0V, V _{CE} =1200V		-	-	3.0	mA
Gate-Emitter leakage current	I _{GES}	V _{CE} =0V, V _{GE} =±20V		-	-	600	nA
Gate-Emitter threshold voltage	$V_{\text{GE(th)}}$	V _{CE} =20V, I _C =3	300mA	6.0	6.5	7.0	V
			T _j =25°C	-	2.20	2.65	- V
	V _{CE(sat)} (terminal)		T _j =125°C	-	2.50	-	
Collector-Emitter	(terrilliai)	$V_{GE} = 15V$ $I_{C} = 300A$	T _j =150°C	-	2.55	-	
saturation voltage			T _j =25°C	-	1.75	2.20	
	V _{CE(sat)} (chip)		T _j =125°C	-	2.05	-	
			T _i =150°C	-	2.10	-	
Internal gate resistance	$R_{G(int)}$	-	,	-	2.5	-	Ω
Input capacitance	C _{ies}	V _{CE} =10V, V _{GE} =0V, f=1MHz		-	27	-	nF
	t _{on}			-	450	-	nsec
Turn-on time	t _r	V _{CC} = 600V	$I_{C} = 300A$	-	100	-	
	t _{r(i)}	$V_{GE} = \pm 15V$ $R_{G} = 0.9$	$R_G = 0.93\Omega$	-	50	-	
Turn-off time	$t_{\rm off}$	L _s = 30nH		-	650	-	
Turn-on time	t _f			-	55	-	
	V _F (terminal)	V _{GE} = 0V I _F = 300A	T _j =25°C	-	2.15	2.60	- V
			T _j =125°C	-	2.30	-	
Farward on voltage	(terrillial)		T _j =150°C	-	2.25	-	
Forward on voltage	V _F (chip)		T _j =25°C	-	1.70	2.15	
			T _j =125°C	-	1.85	-	
			T _i =150°C	-	1.80	-	
Reverse recovery time	t _{rr}	I _F = 300A	,	-	100	-	nsec
Thermistor Resistance	Resistance R	T=25°C T=100°C		-	5000	-	Ω
THEIMISION MESISIANCE				465	495	520	
Thermistor B value	В	T=25/50°C		3305	3375	3450	K

5. Thermal resistance characteristics

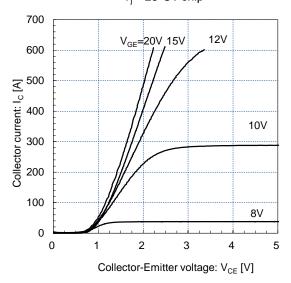
Items	Symbols	Conditions	Characteristics			Units
items	Symbols	Conditions	min.	typ.	max.	Units
Thermal resistance	R _{th(j-c)}	IGBT	-	-	0.075	°C/W
(1device)		FWD	-	-	0.120	
Contact thermal resistance (1device) (*1)	R _{th(c-f)}	with thermal compound	-	0.0167	-	C/VV

^(*1) This is the value which is defined mounting on the additional cooling fin with thermal compound.

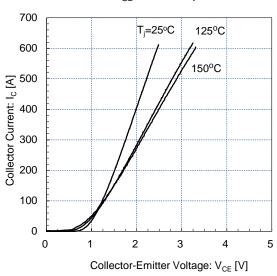


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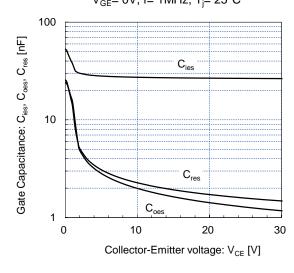
Collector current vs. Collector-Emitter voltage $T_i = 25^{\circ}C / chip$



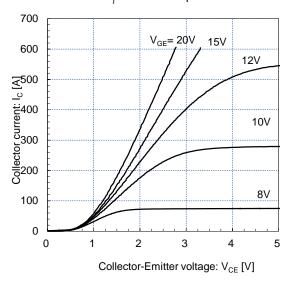
Collector current vs. Collector-Emitter voltage $V_{GE} = 15V / chip$



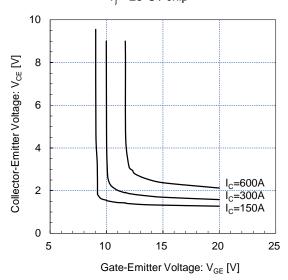
Capacitance vs. Collector-Emitter Voltage V_{GE} = 0V, f= 1MHz, T_i = 25°C



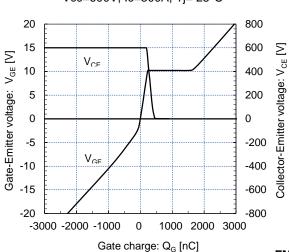
Collector current vs. Collector-Emitter voltage (typ.) $T_i = 150^{\circ}C$ / chip



Collector-Emitter voltage vs. Gate-Emitter voltage $T_i = 25^{\circ}C$ / chip



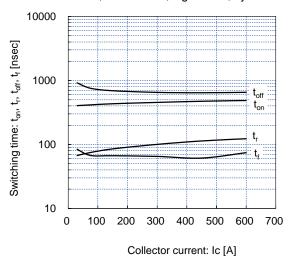
Dynamic Gate Charge (typ.) Vcc=600V, Ic=300A, Tj= 25°C



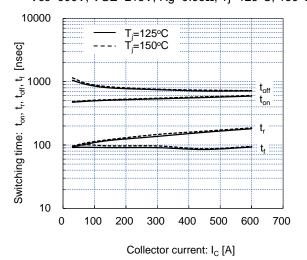


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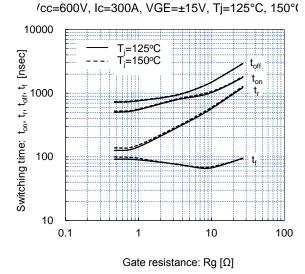
Switching time vs. Collector current (typ.) Vcc=600V, $VGE=\pm15V$, $Rg=0.93\Omega$, $Tj=25^{\circ}C$



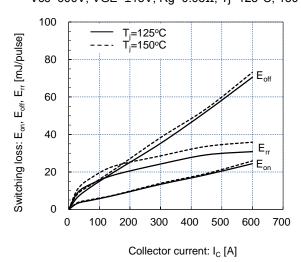
Switching time vs. Collector current (typ.) Vcc=600V, VGE=±15V, Rg=0.93Ω, Tj=125°C, 150°C



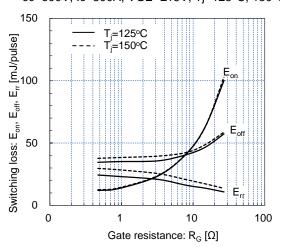
Switching time vs. Gate resistance (typ.)



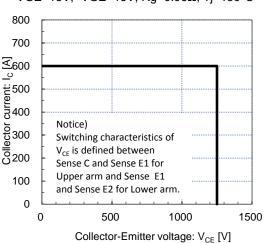
Switching loss vs. Collector current (typ.) Vcc=600V, VGE=±15V, Rg=0.93Ω, Tj=125°C, 150°C



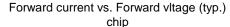
Switching loss vs. Gate resistance (typ.) /cc=600V, Ic=300A, VGE=±15V, Tj=125°C, 150°C

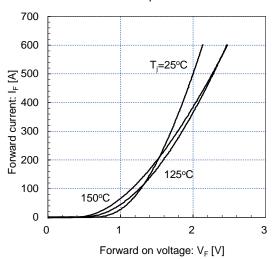


Reverse bias safe operating area (max.) +VGE=15V, -VGE=15V, Rg=0.93Ω, Tj=150°C

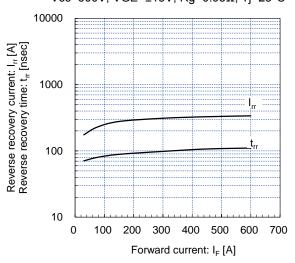


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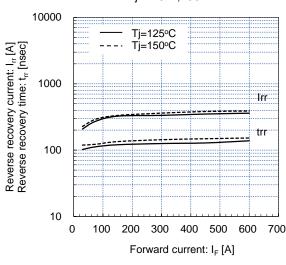




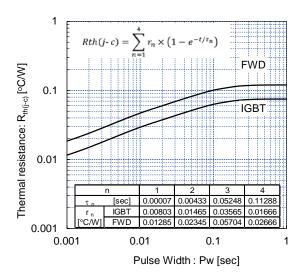
Reverse recovery characteristics (typ.) Vcc=600V, VGE=±15V, Rg=0.93Ω, Tj=25°C



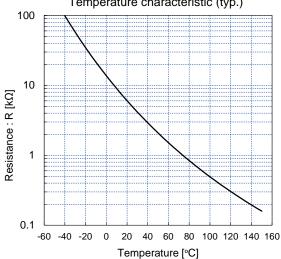
Reverse Recovery Characteristics (typ.) Tj=125°C,150°C



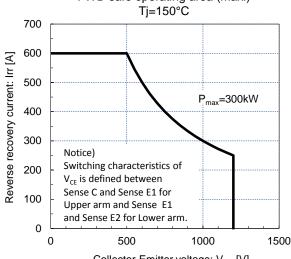
Transient Thermal Resistance (max.)



[THERMISTOR] Temperature characteristic (typ.)



FWD safe operating area (max.)



Collector-Emitter voltage: $V_{CE}[V]$

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